56E D ■ 7110826 0041496 663 ■PHIN

## SCHOTTKY-BARRIER RECTIFIER DIODES

Low-leakage, platinum-barrier rectifier diodes in metal envelopes, featuring low forward voltage drop, low capacitance, absence of stored charge and high temperature stability. They are intended for use in low output voltage switched-mode power supplies and high frequency circuits in general, where both low conduction losses and zero switching losses are important. They can also withstand reverse voltage transients and have guaranteed reverse avalanche surge capability. The series consists of normal polarity (cathode to stud) types.

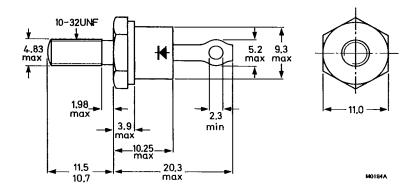
#### **QUICK REFERENCE DATA**

|                                 |                | BY\  | /121- 35 | 40  | 45 |    | 4 |
|---------------------------------|----------------|------|----------|-----|----|----|---|
| Repetitive peak reverse voltage | $v_{RRM}$      | max. | 35       | 40  | 45 | V  |   |
| Average forward current         | IF(AV)         | max. |          | 30  | _  | Α  |   |
| Forward voltage                 | ٧ <sub>F</sub> | <    |          | 0,6 |    | V  |   |
| Junction temperature            | $T_{j}$        | max. |          | 150 |    | оС |   |
|                                 |                |      |          |     |    |    |   |

#### **MECHANICAL DATA**

Dimensions in mm

Fig. 1 DO-4 with 10-32 UNF stud ( $\phi$ 4.83 mm) as standard. Metric M5 stud ( $\phi$ 5 mm) is available on request; e.g. BYV121-35M.



Net mass: 7 g

Diameter of clearance hole: 5.2 mm

Accessories supplied on request: 56295a (mica washer); 56295b (PTFE ring); 56295c (insulating bush).

Supplied with device: 1 nut, 1 lock washer. Torque on nut:
min. 0.9 Nm (9 kg cm),
max. 1.7 Nm (17 kg cm).
Nut dimensions across the flats:
10-32 UNF, 9.5 mm; M5, 8.0 mm.

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# **BYV121 SERIES**

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#### **RATINGS**

Limiting values in accordance with the Absolute Maximum System (IEC 134).

| - | Voltages   |                    |              | BYV121 35    | 40         | 45 |        |
|---|--|--------------------|--------------|--------------|------------|----|--------|
|   | Repetitive peak reverse voltage  | VRRM               | max.         | 35           | 40         | 45 | V      |
|   | Crest working reverse voltage  | VRWM               | max.         | 35           | 40         | 45 | V      |
|   | Continuous reverse voltage   | $v_R$              | max.         | 35           | 40         | 45 | V      |
|   | Currents   |                    |              | <del>-</del> |            |    |        |
|   | Average forward current square wave; $\delta$ = 0.5; up to $T_{mb}$ = 120 °C (note 1) sinusoidal; up to $T_{mb}$ = 122 °C (note 1)       | <sup>[</sup> F(AV) | max.<br>max. |              | 30<br>27   |    | A<br>A |
|   |  | F(AV)              |              |              |            |    |        |
|   | R.M.S. forward current   | F(RMS)             | max.         |              | 42.5       |    | Α      |
|   | Repetitive peak forward current $t_p = 20 \mu s$ ; $\delta = 0.02$   | <sup>i</sup> FRM   | max.         |              | 500        |    | A      |
|   | Non-repetitive peak forward current half sine-wave; $T_j = 125$ °C prior to surge; with reapplied $V_{RWM}$ max $t = 10$ ms $t = 8.3$ ms | IFSM<br>IFSM       | max.<br>max. |              | 600<br>650 |    | A<br>A |
|   | I <sup>2</sup> t for fusing (t = 10 ms)  | l² t               | max.         |              | 1800       |    | A²s    |
|   | Reverse surge current<br>$t_p = 2 \mu s; \delta = 0.001$<br>$t_p = 100 \mu s$  | IRRM<br>IRSM       | max.<br>max. |              | 2.0<br>2.0 |    | A<br>A |
|   | Temperatures   |                    |              |              |            |    |        |
|   | Storage temperature  | T <sub>stg</sub>   |              | -55 to       | +150       |    | οС     |
|   | Junction temperature   | Tj                 | max.         |              | 150        |    | οС     |
|   |  |                    |              |              |            |    |        |

### MOUNTING INSTRUCTIONS

The top connector should be neither bent nor twisted; it should be soldered into the circuit so that there is no strain on it.

During soldering, the heat conduction to the junction should be kept to a minimum.

#### Note:

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<sup>1.</sup> Assuming no reverse leakage current losses.

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|----|--|-----|---|--|-------------|--------------------|-------------------|-----|
| 7  | HERMAL RESISTANCE  |     |   |  |             |                    |                   |     |
| F  | rom junction to mounting base  |     |   | R <sub>th j-mb</sub>   | =           | 1.0                | K/W               |     |
| V  | From mounting base to heatsink<br>vith heatsink compound<br>vithout heatsink compound<br>Fransient thermal impedance; t = 1 ms |     |   | R <sub>th mb-h</sub><br>R <sub>th mb-h</sub><br>Z <sub>th j-mb</sub> | =<br>=<br>= | 0.3<br>0.5<br>0.15 | K/W<br>K/W<br>K/W |     |
| C  | CHARACTERISTICS  |     |   |  |             |                    |                   |     |
| F  | Forward voltages<br>$I_F = 34 \text{ A}; T_j = 150 ^{\circ}\text{C}$<br>$I_F = 60 \text{ A}; T_j = 25 ^{\circ}\text{C}$        |     |   | V <sub>F</sub><br>V <sub>F</sub>                                     | <<br><      | 0.6<br>0.83        | V*<br>V*          |     |
| F  | Reverse current  VR = VRWM max; Tj = 125°C  VR = VRWM max; Tj = 25 °C  |     |   | I <sub>R</sub>   | <<br><      | 200<br>0.1         | mA<br>mA          |     |
| J  | unction capacitance at $f = 1 \text{ MHz}$<br>V <sub>R</sub> = 5 V; T <sub>j</sub> = 25 to 125 °C                              |     |   | $c_d$  | typ.        | 1150               | рF                |     |

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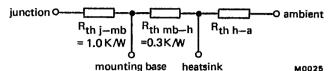
<sup>\*</sup>Measured under pulse conditions to avoid excessive dissipation.

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#### **OPERATING NOTES**

### Dissipation and Heatsink Calculations

The various components of junction temperature rise above ambient are shown below:



Overall thermal resistance,  $R_{th j-a} = R_{th j-mb} + R_{th mb-h} + R_{th h-a}$ 

To choose a suitable heatsink, the following information is required:

- (i) maximum operating ambient temperature
- (ii) duty cycle or form factor of forward current ( $\delta$  or a)
- (iii) average forward current
- (iv) crest working reverse voltage (VRWM)

The total power dissipation in the diode has two components:

$$P_{tot} = P_R + P_F \dots 1).$$

Fig.2.

P<sub>F</sub> — forward conduction dissipation

From the above it can be seen that:

Values for  $R_{th\ j\text{-mb}}$  and  $R_{th\ mb\text{-}h}$  can be found under Thermal Resistance.  $P_R$  and  $P_F$  are derived from Figs.3 and 4 for square-wave operation (and Figs.5 and 6 for sine-wave) as follows:

Starting at the V<sub>RWM</sub> axis of Fig.3 (or Fig.5), and from a knowledge of the required V<sub>RWM</sub>, trace upwards to meet the curve that matches the required  $T_{jmax}$ . From this point trace horizontally left until the curve of the voltage grade of the device being used is met. From this point trace downwards to meet the required duty cycle ( $\delta$ ) or form factor (a). From this point trace right and read the actual reverse power dissipation on the  $P_R$  axis.

Foward conduction dissipation (P<sub>F</sub>) for the known average current I<sub>F(AV)</sub> and duty cycle (or form factor) is easily derived from Fig.4 (or Fig.6).

Substituting the values of PR and Pp into equation 2) enables the calculation of the required heatsink.

To ensure thermal stability,  $(R_{th\ j-mb} + R_{th\ mb-h} + R_{th\ h-a}) \times P_R$  must be less than 12 °C. If the calculated value of  $R_{th\ h-a}$  does not permit this, then it must be reduced (heatsink size increased or  $R_{th\ mb-h}$  improved) to enable this criterion to be met.

**EXAMPLE:** 

square-wave operation, using BYV121-35 and heatsink compound;

$$T_{amb} = 30$$
 °C;  $\delta = 0.5$ ;  $I_{F(AV)} = 20$  A

From data,  $R_{th j-mb}$  = 1.0 K/W and  $R_{th mb-h}$  = 0.3 K/W.

From Fig.4, it is found that PF = 12 W

If desired  $T_{imax}$  is chosen to be 120 °C, then, from Fig.3,  $P_R = 0.4 \text{ W}$ 

Using equation 2) we have:

$$R_{\text{th h-a}} = \frac{120 \, ^{\circ}\text{C} - 30 \, ^{\circ}\text{C}}{12 \, \text{W} + 0.4 \, \text{W}} - (1.0 + 0.3) = 6 \, \text{K/W}$$

To check for thermal stability:

$$(R_{th i-a}) \times P_R = (1.0 + 0.3 + 6) \times 0.4 = 2.9 \, ^{\circ}C.$$

This is less than 12 °C, hence thermal stability is ensured.

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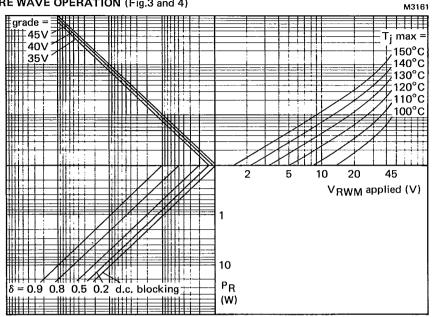
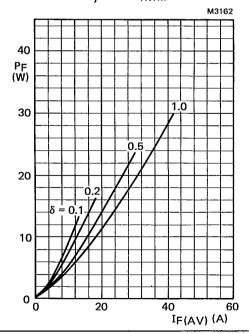


Fig.3 NOMOGRAM: for calculation of PR (reverse leakage power dissipation) for a given Ti max., VRWM applied, voltage grade and duty cycle.



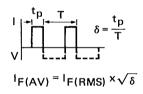
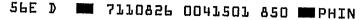


Fig.4 Forward current power rating.



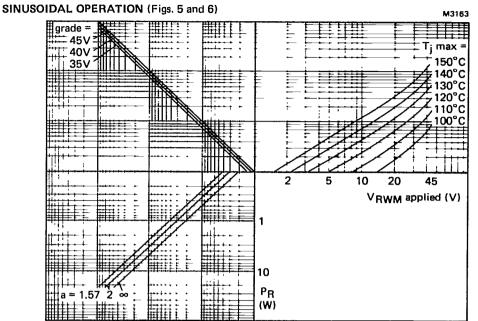


Fig.5 NOMOGRAM: for calculation of PR (reverse leakage power dissipation) for a given T $_j$  max., VRWM applied, voltage grade and form factor.

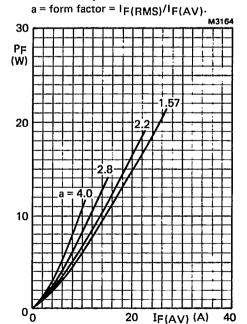


Fig.6 Forward current power rating.

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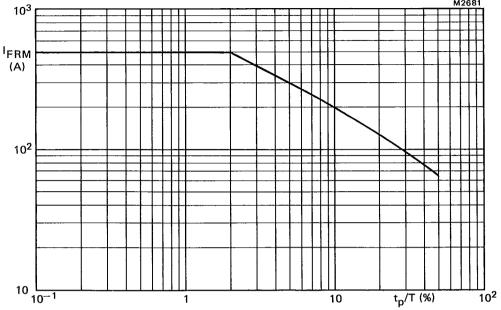
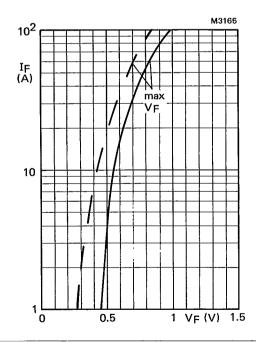
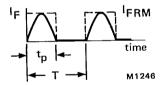


Fig.7 Maximum permissible repetitive peak forward current for either square or sinusoidal current for 1  $\mu$ s < t $_{D}$  < 1 ms.

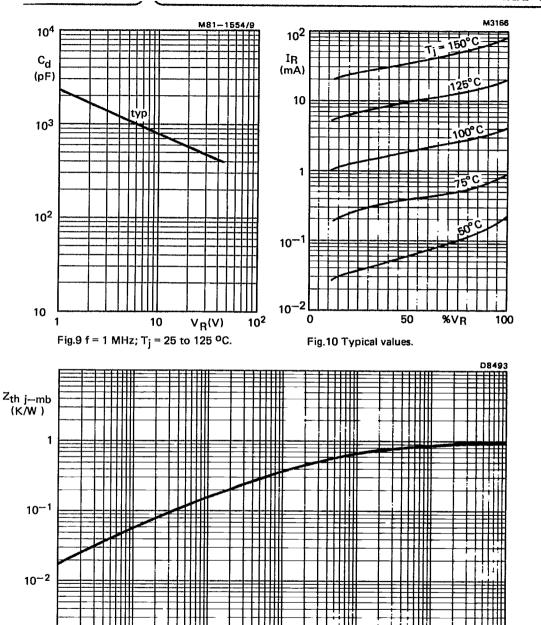




Definition of IFRM and  $t_p/T$ .

Fig.8 —— 
$$T_j = 25$$
 °C; ——  $T_j = 150$  °C.

time (s)



10-2 Fig.11 Transient thermal impedance.

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 $10^{-3}$ 

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10-3